

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2669556

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>YU-HSIEN CHIN</td> <td>12/20/2013</td> </tr> <tr> <td>CHIH-CHIA HSU</td> <td>12/17/2013</td> </tr> <tr> <td>YIN-FU HUANG</td> <td>12/17/2013</td> </tr> </tbody> </table>		Name	Execution Date	YU-HSIEN CHIN	12/20/2013	CHIH-CHIA HSU	12/17/2013	YIN-FU HUANG	12/17/2013
Name	Execution Date								
YU-HSIEN CHIN	12/20/2013								
CHIH-CHIA HSU	12/17/2013								
YIN-FU HUANG	12/17/2013								
RECEIVING PARTY DATA									
Name:	MACRONIX INTERNATIONAL CO., LTD.								
Street Address:	NO.16, LI-HSIN RD.								
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK								
City:	HSINCHU								
State/Country:	TAIWAN								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14138213</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14138213				
Property Type	Number								
Application Number:	14138213								
CORRESPONDENCE DATA									
Fax Number:	(404)521-4286								
Phone:	6784838899								
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<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>									
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NAME OF SUBMITTER:	DANIEL R. MCCLURE								
Signature:	/Daniel R. McClure/								

Date:	01/07/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 3 source=00118504#page1.tif source=00118504#page2.tif source=00118504#page3.tif	

Attorney Reference: _____

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Yu-Hsien Chin, Chih-Chia Hsu and Yin-Fu Huang
hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to
SEMICONDUCTOR STRUCTURE AND MANUFACTURING PROCESS THEREOF

said application being attached hereto;

said application having been filed in the United States Patent and Trademark Office on _____, as Application Serial No. _____, and was amended on: _____ (if applicable);

the specification of which was filed under the Patent Cooperation Treaty on _____, Serial No. _____, the United States of America being designated.

AND WHEREAS MACRONIX INTERNATIONAL CO., LTD., hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: Yu-Hsien Chin *12/20*

Legal Name: Yu-Hsien Chin

Date: 2013.12.20

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (SECOND INVENTOR):

Signature: _____

Legal Name: Chih-Chia Hsu

Date: _____

WITNESS:

Signature: _____

Name: _____

Address: _____

ASSIGNOR (THIRD INVENTOR):

Signature: _____

Legal Name: Yin-Fu Huang

Date: _____

WITNESS:

Signature:

Name:

Address:

.....

WITNESS:

Signature:

Name:

Address:

.....

WITNESS:

Signature:

Name:

Address:

.....

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature:

Legal Name: Yu-Hsien Chin

Date:

ASSIGNOR (SECOND INVENTOR):

Signature: Chih-Chia Hsu

Legal Name: Chih-Chia Hsu

Date: 2013.12.17

ASSIGNOR (THIRD INVENTOR):

Signature: Yin-Fu Huang

Legal Name: Yin-Fu Huang

Date: 2013.12.17